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**Customer Notification** 

# IE-703037-MC-EM1

## In-circuit Emulator Option

**Operating Precautions** 

Traget Device V850/SB1

Global Document No. U18077EE6V0IF00 (6th edition) Document No. IE\_703037\_TPS-HE-B-2725 Date Published May 2002 N

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## (A) Table of Operatiing Precautions

No.	Outline	EM1 board				
		А	В	С	D	Е
		1.32	1.33	1.34	1.35	2.00
1	Restrictions related to CLKOUT	€ <sup>™</sup>	€×	<b>€</b> <sup>%</sup>	<b>€</b> <sup>%</sup>	<b>6</b> %
2	Restriction when INTWDT interrupt is generated	6.K	W.S.	1	1	1
3	Restriction IIC-bus function	mit with	W.	~	~	✓
4	When P33 is used as S04, P31 does not operate correctly as an output port.	W.	Parks.	1	1	1
5	If the compare register is written to at the moment when the compare register matches TM2-7, a matching signal is not generated	W.	ι.β.	1	1	~
6	If the timing of releasing the STOP mode conflicts with the timing of entering the STOP mode, the ICE becomes deadlocked	W.	W.S.	1	1	1
7	When P113 is set as am output port, interrupt processing is not performed	W.	land a	1	1	1
8	SB2 cannot be emulated	mit .	~	~	~	1
9	INTC (interrupt controller)	min and a second	WY.	1	1	1
10	Restriction on SFR illegal access break.	1	<b>€</b> <sup>™</sup>	<b>€</b> <sup>™</sup>	<b>€</b> <sup>™</sup>	<b>*</b> **
11	Restriction on initial value of PM6 and PM9	<b>●</b> <sup>™</sup>	<b>é</b> ×	<b>é</b> *	<b>é</b> *	€ <sup>™</sup>
12	Restriction on P11 when set as output port	<b>●</b> <sup>™</sup>	<b>é</b> ×	<b>é</b> *	<b>é</b> *	€ <sup>™</sup>
13	Restrictions on interrupt in STOP/IDLE mode.	W.S.	W.	W.S.	W.S.	1
14	Initial value of pull up resistor option register P10 (PU10)	W.S.	19	WS.	1	1
15	Baud rate setting for variable- length serial interface CSI4	<b>●</b> <sup>™</sup>	<b>S</b>	<b>é</b> ×	<b>é</b> ×	€ <sup>™</sup>
16	Double interrupt execution	<b>€</b> <sup>™</sup>	<b>6</b> <sup>%</sup>	<b>6</b> <sup>%</sup>	<b>*</b>	<b>6</b> <sup>%</sup>

#### **OPERATING PRECAUTIONS for IE-703037-MC-EM1**

17	16-bit timer (one-shot pulse mode)	<b>6</b> **	<b>6</b> <sup>%</sup>	<b>*</b>	<b>*</b> *	<b>*</b> **
18	El instruction	€×	<b>*</b> *	<b>*</b> *	€ <sup>™</sup>	
19	Power save function	€×	<b>*</b> *	<b>•</b> **	€ <sup>™</sup>	
20	Products emulation restriction	€ <sup>™</sup>	€ <sup>%</sup>	<b>*</b> *	<b>6</b> **	1

#### ✓: No problem

- \*: Will be corrected by version upgrade
- Restriction, not corrected by version upgrade

## (B) Description of Precautions

No.	Outline	Description
1	Restrictions on CLKOUT	Details
	GEROOT	In case of reset, the CLOCKOUT is still available
		Workaround
		none
2	INTWDT interrupt	Details
	generation	When the interrupt INTWDT (non maskable) has been generated, processing does not branch to the correct handler address (0x20h), but to the address 0x30h (an unused handler address in the device).
		Workaround
		Insert the same processing as the program at 0x20h at the address 0x30h.
3	IIC-bus functions	Details
		The IIC bus is not currently supported.
		Workaround
		none
4	Output on port pin	Details
	P33	When P33 is used for SO4, P31 does not work correctly as output port.
		Workaround
		Use the port pin P31 only as inport pin, when port pin P33 is used for SO4.
5	TM 2-7 operational	Details:
	defect	When used in interval timer mode If the compare register (CR20-70) is written when the timer register (TM2-7) and compare register (CR20-70) coincide, a coincidence signal is not generated. For this reason, the software must be designed to prevent timer coincidence and writing the compare register occurring at the same time. (Example: use a Vector interrupt)
		When used in square wave output mode If the compare register (CR20-70) is written when the timer register (TM2-7) and compare register (CR20-70) coincide, a coincidence signal is not generated and the output waveform does not invert. For this reason, the software must be designed to prevent timer coincidence and writing the compare register occurring at the same time. (Example: use a Vector interrupt)

Interval timer and square wave output (Normal operation)
тм500нХ 01нХ 02нХ 03нХ 04нХ 00нХ 01нХ 02нХ 03нХ 04нХ 00нХ 01нХ 02нХ 03нХ
CR5 X04H
тсе5
T05
Interval timer and square wave outout (Incorrect operation)
тм5ОНХ 01НХ 02НХ 03НХ 04НХ 05НХ 06Н 🖉 ЕГНХ 00НХ 01НХ 02НХ 03НХ 04НХ 00НХ
CR5 X 04H XX CR5 04H same operation for other values
Write signal for CR5
<u> </u>
TCE5
T05
The timing chart above is intend to show the general operation and does not show precise timing

5	TM 2-7 operational	When used in PWM output mode
	defect	- If the CR20-70 (master register) is re-written at the same time as the timer register overflows when the CR20-70 (master register) is written, the expected data sometimes cannot be transferred to the CR20-70 (slave register). (Data value is undefined) The software must be designed to prevent the overflow occurring at the same time as writing in the compare register.
		PWM timer (Incorrect operation)
		TM5         00HX01HX02HX03H         XFEHXFEHX00HX01HX02HX03H         XM+1X           Write signal for CR5
		CR5(M) M ZZ Not re-loaded
		CR5(S) <
		TCE5
		PWM timer (Incorrect operation)
		тм500HX_01HX_02HX_03H55X FEHX_FFHX_00HX_01HX_02HX_03F65_M-1X_M_XM+1X Read sign <u>al for CR5</u>
		CR5(M)
		CR5(S)
		TCE5 Coincidence signal does not occur Coincidence signal
		OVF
		TO5
		The Timing chart above is intendend to show the general operation, and does not show precise timing.

5	TM 2-7 operational	
Ũ	defect	- If the CR20-70 register is read when an overflow occurs, the CR20-70
		master register will not transfer data to the CR20-70 slave register. The data is transferred when the next overflow occurs.
		PWM timer (Incorrect operation)
		тмбОНХ О1НХ О2НХ О3Н \$ ХЕЕНХ ГЕНХ ООНХ О1НХ О2НХ 03В 5М-1 Х.М. ХМ+1Х
		Write signal for CR5
		CR5(M) Not re-loaded
		CR5(S)
		тсеб
		OVF
		то сс
		The Timing chart above is intendend to show the general operation, and does not show precise timing.
		If the company register (CD00.70) is written when the timer register
		- If the compare register (CR20-70) is written when the timer register (TM2-7) and compare register (CR20-70 [slave register]) coincide, a
		coincidence signal is not generated and the inactive level is not
		attained.
		PWM timer (Incorrect operation)
		тм5ОНХ ОЗНХ ОЗНХ СЭНХ ГЕНХ ГЕНХ ООНХ ОЛНХ ОЗНХ ОЗНХ ОЗНХ М-1 ХМ ХМ+1Х
		Read signal for CR5
		CR5(S)
		TCE5 Coincidence signal does not occur
		Coincidence signal
		0VF
		(INTTM5) TO5 ~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~
		Does not become inactive level
		The Timing chart above is intendend to show the general operation, and does not show precise timing.
		····· ··· · · · · · · · · · · · · · ·

6	STOP conflict	The CPU becomes deadlocked, if the timing of a STOP mode enable and a Stop mode release are in conflict
		Details With the V050/SP1, the STOP mode is enable by writing (stop, loc) to the
		With the V850/SB1, the STOP mode is enable by writing (stop_le:) to the PSC register (Power Save Control register). To release the Stop mode, the count initialization signal (oststart:) is generated to start the WDT (watchdog timer) that counts out the oscillation stabilization time (refer to diagram 1). However, if the stop mode release signal (relstp:) because of an interrupt, etc. conflicts with writing to the PSC register (the timing for this precaution occur within 2 clocks), then the oststart signal is not generated and WDT does not start counting. This means that the microcomputer remains waiting for the oscillation stabilization time to
		elapse, and even if the stop mode release signal is generated, STOP mode cannot be released (refer to diagram 2).
		Workaround
		As a temporary measure it is suggest that you use the IDLE mode or sub- IDLE mode instead of the STOP mode.
		relstp (STOP release signal)
		oststart (OST count)
		stop_le (PSC bit1)
		stpf0_21 (OSCD internal signal)
		stpf1_21 (OSCD internal signal)
		stpf2_21 (OSCD internal signal)
		PSC write STOP Oscillation Sense-amp status stabilization waiting count
		Diagramm1: STOP release operation timing (Normal)

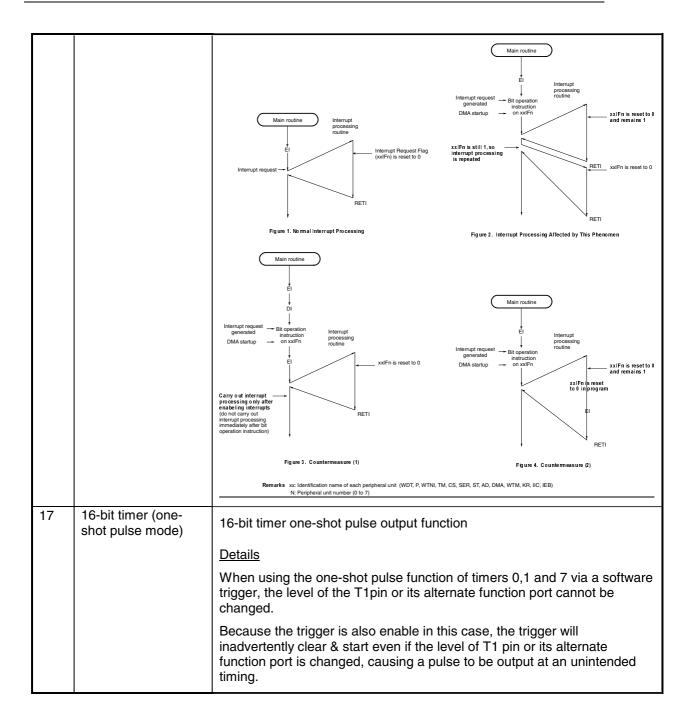
6	STOP conflict	
0		Timing for the conflict, occur within 2 clocks
		relstp (STOP release signal) oststart (OST count) stop_le (PSC bit1) stpf0_21 (OSCD internal signal) stpf1_21 (OSCD internal signal) stpf2_21 (OSCD internal signal) oscillation stabilization count PSC write Diagramm 2: Timing of conflict between STOP mode enable and release (Error)
7	Interrupt of P113	Details
		If P113 is specified as an output port, interrupt processing will not work.
		Workaround
		Use P113 as an input port.
8	SB2 cannot be	Details
Ĩ	emulated	SB2 cannot be emulated
		Workaround
		none

9	INTC (interrupt	Details
	controller)	This behaviour is the same as that on the original device. Bit operations setl, clrl, notl, tstl are Read-Modify-Write instructions (RMW). This means that this operation reads out the value of a register that is to change to an internal buffer, changes the value, and writes the value to the register.
		If a cycle in which the hardware of a register on which RMW operation is performed is set/reset <sup>Note</sup> and a DMA cycle conflict, set resetting the hardware of the register is cancled.
		Example: If the DMA cycle started by a DMA start request (such as INTCSIn) coincides with the DMA transfer count end interrupt (INTDMAn) in a bit manipulation instruction cycle to an interrupt control register (DMAICn)
		Note: Interrupt control register (xxIC), In-service priority register (ISPR)
		Workaround
		Registers that are set or reset by hardware are the Interrupt control registers (xxIC) and In-service Priority Register (ISPR). Do not use a bit operation instruction on these registers. Restriction: Do not use xxIC register and ISPR register as the DIOAn register (DMA peripheral address register). (When using DMA, do not access the xxIC and ISPR registers.)

10	Restriction on SFR	<u>Details</u>				
	illegal access break	Tehre are s	ome addresses	that are reserv	ed areas but for	wich an SFR
					he addresses ar	
			Emulation of CD1	Emulation of CD1	Emulation of SB2	Emulation of CD0
			Except Y Product)		(Except Y Product)	
		0xFFF138	x	0	x	0
		0xFFF340	х	0	Х	0
		0xFFF342 0xFFF344	x x	0 0	x x	0
		0xFFF346	x	0	x	0
		0xFFF348	х	0	Х	0
		0xFFF34A	x	0	x	0
		0xFFF34C 0xFFF350	X X	0 0	x x	0
		0xFFF352	x	0	X	0
		0xFFF354	х	0	X	0
		0xFFF356 0xFFF358	x	0	X	0
		0xFFF358 0xFFF35A	X X	0 0	X X	0 0
		0xFFF35C	x	0	x	0
		0xFFF142	х	Х	0	0
		0xFFF144 0xFFF3E0	x x	x x	0 0	0
		0xFFF3E0	x	X	0	0
		0xFFF3E4	x	x	0	0
		0xFFF3E6	х	Х	0	0
		0xFFF3E8 0xFFF3EA	x x	X X	0 0	0 0
		0xFFF3EC	X	X	0	0
		0xFFF3EE	х	Х	0	0
		0xFFF3F0	x	X	0	0
		0xFFF3F2 0xFFF3F4	x x	x x	0 0	0 0
		0xFFF3F6	x	X	0	0
		0xFFF3F8	х	х	0	0
			er illegal break er illegal break			
		Ŭ	0			
		Workaround	<u>d</u>			
		Be particula restriction.	arly careful with	SFR accesses.	This will becom	e a permanent
11	Restriction on initial	Details				
	values of PM6 and PM9		alues of PM6 ar	nd PM9 at reset	are different from	m the real chip:
1		SFR	Address	ICE Read V	alue Real Chip	Read Valu
		PM6	0xFFF02		3F	
		PM9	0xFFF03	2 FF	7F	
		Workaround	<u>b</u>			
				ermanent restri	ction	
		110110. 11113				

12	Restriction on P11	Description
	when set as output port	If P11 is read when set as output port, the pin status is read instead of the port register value.
		Workaround
		There are no workaround. Please regard this as a permanent restriction.
13	Restriction on	Description
	interrupts in Stop/Idle mode	The emulator is dead-locked under the following conditions.
		If the device is shifted to the STOP/IDLE mode while the interrupt request flag is set by an interrupt that is not masked.
		Workaround
		Be sure to clear the non-masked interrupt request flag before entering the STOP/IDLE mode. If the device is inadvertently shifted before clearing the flag, execute "Go"->"Halt". The program is forcibly terminated. Then, execute "Go"->"Reset" to restart the emulator
14	Initial value of pull-	Description
	up resistor option register P10 (PU10)	The on-chip pull-up resistors are connected to ports 100 to 107 direct after debugger start up or after a reset (including the time from immediately after emulator power-on to debugger start up). Even though the value of the pull up resistor option register P10 (PU10) is displayed as 00h (on-chip pull-up resistor is not connected) on the debugger at that time. Workaround
		Write 00h to pull-up resistor option register 10 (PU10) during initialisation immediately after a reset or in the I/O register window.
		This workaround has been implemented in products with control code D and later.
15	Baud rate setting for variable-length serial interface CSI4	DetailsOn CSI4 data is not transmitted correctly if the baud rate of variable length CSI (CSI4) is set to a transmission speed faster than or equal to the operating clock of the CPU.Example:When operating at $f_{CPU} = f_{XX}/2$ , the baud rate $f_{XX}/2$ cannot be selected When operating at fCPU = $f_{XX}/4$ , the baud rates $f_{XX}/2$ and $f_{XX}/4$ cannot be selected When operating at $f_{CPU} = f_{XX}/8$ , the baud rates $f_{XX}/2$ , $f_{XX}/4$ and $f_{XX}/8$ cannot be selectedWhen operating at $f_{CPU} = f_{XX}/8$ , the baud rates $f_{XX}/2$ , $f_{XX}/4$ and $f_{XX}/8$ cannot be selectedWhen operating at $f_{CPU} = f_{XX}$ all baud rates can be selected. This restriction does not apply to CSI0 – CS13 or UART0 – UART1. Workaround:
		Do not use baud rates faster than or equal to the operating clock of the CPU for CSI4.

16	Double interrupt execution	Details		
		<ul> <li>An interrupt that should occur only once occurs twice if the following three conditions occur simultaneously while interrupts are enabled:</li> <li>1) A bit manipulation instruction (set1, clr1, not1 or tst1) is executed on an interrupt request flag (xxIFn) of an interrupt control register (xxICn).</li> <li>2) Interrupt processing involving the hardware of the same register occurs</li> <li>3) There is a DMA startup while executing the above bit operation</li> <li>Remark: xx: Identification name of a peripheral unit (WDT, P, WTNI, TM, CSI, SER, ST, AD, DMA, WTN, KR, IIC) n: peripheral unit number</li> </ul>		
		If the abovementioned condition appears, the Interrupt Request Flag, which is normally reset to 0 at the acknowledge of interrupt processing, will not be reset. Consequently, after returning from interrupt processing (reti instruction), the interrupt processing is executed again. This does not happen if DMA is not used.		
		Example:		
		During a bit manipulation operation using the clr1 instruction on the interrupt request flag of the CSIC0 register (CSIF0), the non-masked INTCSI0 interrupt occurs at the same time as a DMA startup. As a result the INTCSI0 interrupt processing is executed twice.		
		Workaround:		
		<ol> <li>Insert a DI instruction before and an EI instruction after executing a bit manipulation instruction on an interrupt request flag (xxIFn) of an interrupt control register (xxICn) to avoid carrying out interrupt processing immediately after executing the bit manipulation instruction.</li> <li>When interrupt processing begins, the hardware enters a state where interrupts are disabled. Clear the interrupt request flag in all interrupt processing routines before executing the EI instruction.</li> </ol>		



18	EI instruction	Interrupt servicing acknowledgement after EI instruction		
		<u>Details</u>		
		In this product at least 7 clocks are required as determination time between the generation of an interrupt and its acknowledgement. Because instructions continue to be executed in this period, if the DI instruction(interrupt disable) is executed, interrupts become disabled. This cause all interrupts to be held pending until the re-execution of the EI instruction (interrupt enable). Since this determination time is also when the EI instruction is executed, at least 7 clocks must be allowed before interrupts can be acknowledged after execution of the EI instruction. Consequently, if the DI instruction is executed before these 7 clocks have elapsed, interrupts will be held pending and not acknowledged. To ensure proper acknowledgement of interrupts therefore, insert an instruction (other than those below) of at least 7 execution clocks between the EI and DI instruction.		
		<ul> <li>IDLE/STOP mode setting</li> <li>EI, DI instruction</li> <li>RETI instruction</li> <li>LDSR instruction (for PSW) register</li> <li>Access to interrupt control register (xxICn)</li> </ul>		
		Example: When EI instruction processing is invalid		
		DI : ; MK flag = 0 (interrupt enable) : ; Interrupt request generation (IF flag = 1) EI JR, LP1		
		<ul> <li>7 clcoks have not elapsed between El an DI instructions</li> <li>(3 clocks)</li> <li>LP1:</li> <li>DI</li> <li>:</li> </ul>		
		· Workaround example:		
		DI : ; MK flag = 0 (interrupt enable) : ; Interrupt request generation (IF flag = 1)		
		EI NOP ; 1system clock NOP ; 1system clock NOP ; 1system clock NOP ; 1system clock NOP ; 1system clock		
		JR, LP1 ; 3 system clocks (branch to LP1 routine) : : LP1:		
		DI (Interrupt servicing executed on 8 <sup>th</sup> clock after El instruction		

19	Power save function	Details			
		If the affected products are used under the following conditions, a discrepancy may occur between the address indicated by the program counter (PC) and the address at which the instruction is actually read following the release of the power save mode.			
		<ol> <li>A power save mode (IDLE or STOP) is set while an instruction is being executed on the external ROM.</li> </ol>			
		2. The power save mode is released by an interrupt.			
		<ol> <li>The next instruction is executed while interrupts are in a pending state following the release of the power save mode. Note that interrupts are held pending under any of the following conditions:</li> </ol>			
		- The NP flag of the PSW register is 1. (NMI servicing in progress/s by software)			
		<ul> <li>The ID flag of the PSW register is 1. (Interrupt servicing in progress/DI instruction/set by software)</li> </ul>			
		- The EI (interrupt enable) state had been set during interrupt servicing to enable multiple interrupt servicing, but was released by an interrupt with the same priority than the interrupt being serviced.			
		The operation is shown below, using the power save mode setting example from the user's manual.			
		(rD: PSC setting value, rX : Value written to PSW, rY: Value written back to PSW, assuming PSW has been set)			
		IdsrrX, 5; Sets PSW to the value of rXst.br0, PRCMD[r0]; Writes to PRCMDst.brD, PSC[r0]; Sets the PSC register(PSC setting)IdsrrY,5; Returns the value of PSW(4 bytes)nop; 2 to 5 NOP instructions(6 bytes) *nop;(10 bytes)*nop;(12 bytes)*nop;(14 bytes)*(Next instructions);(16 bytes)			
		* the event occurs here: <1> Discrepancy with PC <2> Instructions ignored			
		Workaround			
		1. Do not use a power save mode (IDLE or STOP) while instruction is being executed on the external ROM.			
		2. If it necessary to use a power save mode (IDLE or STOP) while an instruction is being executed on the external ROM, take the software countermeasures shown below.			
- Insert 6 NOP instructions 4 bytes after an instruction tha PSC register.					

Insert the br 2 instruction after the NOP instructions to eleminate the PC discrepancy.			
Example (rD: PSC setting value, rX: Value written to PSW, rY: Value written back to PSW, assuming PSW has been set)			
	PRCMD[r0] PSC[r0]		
nop nop nop nop nop nop		; <1> 6 or more NOP instructions	
br 2		; <2> Eliminates PC discrepancy	

20	Products emulation restriction	Details
		The following product cannot be emulated.
		V850/SB1: μPD70F3032B(Y), μPD70F3033B(Y), μPD703032B(Y), μPD703030B(Y), μPD703033B(Y), μPD703031B(Y)
		V850/SB2: μPD70F3035B(Y), μPD703035B(Y), μPD703034B(Y), μPD70F3037H(Y), μPD703037H(Y), μPD703036H(Y)

### (C) Revision History

<u>Initial issue:</u> Date: Feb. 09, 1999

<u>2<sup>nd</sup> issue:</u> Date: Jun. 10, 1999 Changes: Update

<u>3<sup>rd</sup> issue:</u> Date: Sep. 21, 1999 Changes: Update

## 4<sup>th</sup> issue:

Date: May. 08, 2001

Changes:

added new version, control code D added additional description to restriction no. 12 on P11 added additional description to restriction no. 13 on interrupt in STOP/IDLE mode added additional description to restriction no. 14 Initial value of pull up register P10 added (C) Revision History

## 5<sup>th</sup> issue:

Date: Jan. 28, 2002

Changes:

added disclaimer added table of contents added additional description to restriction no. 15, on CSI4 added additional description to restriction no. 16, on double interrupt execution added additional description to restriction no. 17, 16-bit timer (one-shot pulse mode) added additional description to restriction no. 18, El instruction added additional description to restriction no. 19, power save function

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6<sup>th</sup> issue: Date: May. 24, 2002 Changes: added new version, control code E corrected no. 5 corrected no. 6 corrected no. 8 added no. 20